

# PW2303

## 30V P-Channel MOSFET

-1.9A -30V;  $R_{DS(ON)typ}=85m\Omega@-10V$ ,  $R_{DS(ON)typ}=125m\Omega@-4.5V$

### FEATURE

- Trench Technology Power MOSFET
- Low  $R_{DS(on)}$
- Low Gate Charge
- Low Gate Resistance

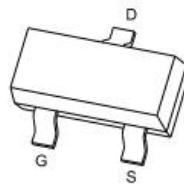
### Application

- DC/DC Converter
- Power Management

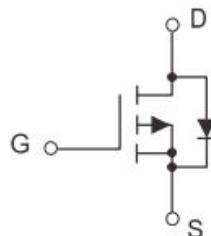
### MARKING:



SOT-23



Schematic diagram



### ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>(1,5)</sup>	$I_D$	-1.9	A
Pulsed Drain Current <sup>(2)</sup>	$I_{DM}$	-7.6	A
Power Dissipation <sup>(4,5)</sup>	$P_D$	0.63	W
Thermal Resistance from Junction to Ambient <sup>(5)</sup>	$R_{\theta JA}$	200	$^\circ C/W$
Junction Temperature	$T_J$	150	$^\circ C$
Storage Temperature	$T_{STG}$	-55~+150	$^\circ C$

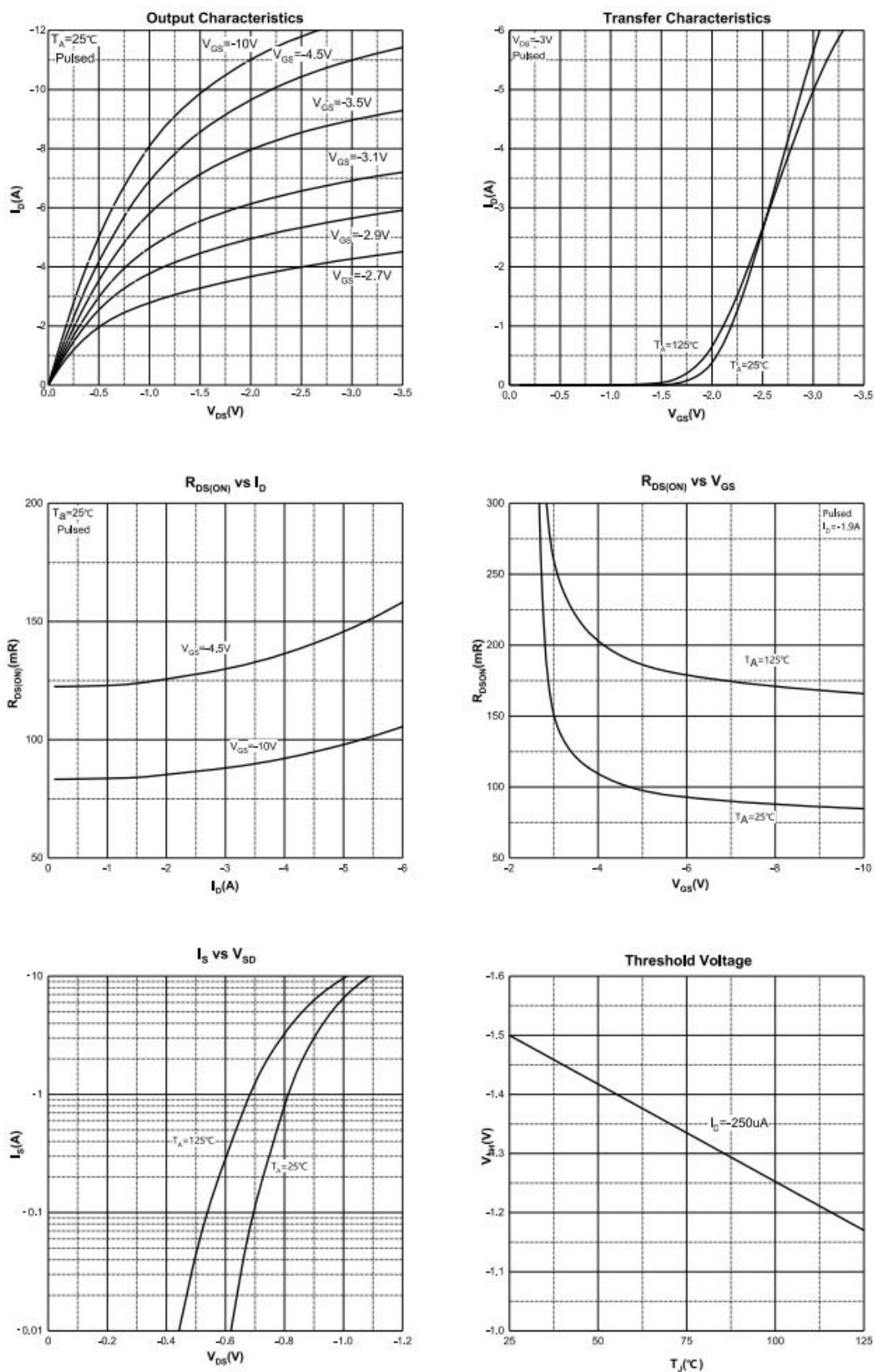
**MOSFET ELECTRICAL CHARACTERISTICS( $T_a=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Off Characteristics</b>						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$	-30			V
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{\text{DS}} = -24\text{V}, V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
Gate-body leakage current	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			$\pm 100$	nA
<b>On Characteristics<sup>(3)</sup></b>						
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = -250\mu\text{A}$	-1.0	-1.5	-3.0	V
Drain-source on-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_{\text{D}} = -1.9\text{A}$		85	150	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -1.4\text{A}$		125	150	
Forward transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = -5\text{V}, I_{\text{D}} = -1.9\text{A}$	2			S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		266		pF
Output Capacitance	$C_{\text{oss}}$			37		
Reverse Transfer Capacitance	$C_{\text{rss}}$			25		
<b>Switching Characteristics</b>						
Total gate charge	$Q_g$	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = -10\text{V}, I_{\text{D}} = -1.9\text{A}$		5.8		nC
Gate-source charge	$Q_{\text{gs}}$			3.2		
Gate-drain charge	$Q_{\text{gd}}$			0.9		
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -15\text{V}, V_{\text{GS}} = -10\text{V}, R_{\text{L}} = 7.5\Omega, R_{\text{G}} = 3\Omega$		6		ns
Turn-on rise time	$t_r$			4		
Turn-off delay time	$t_{\text{d}(\text{off})}$			15		
Turn-off fall time	$t_f$			6		
<b>Source-Drain Diode Characteristics</b>						
Diode Forward voltage <sup>(3)</sup>	$V_{\text{SD}}$	$I_{\text{S}} = -1.5\text{A}, V_{\text{GS}} = 0\text{V}$			-1.2	V

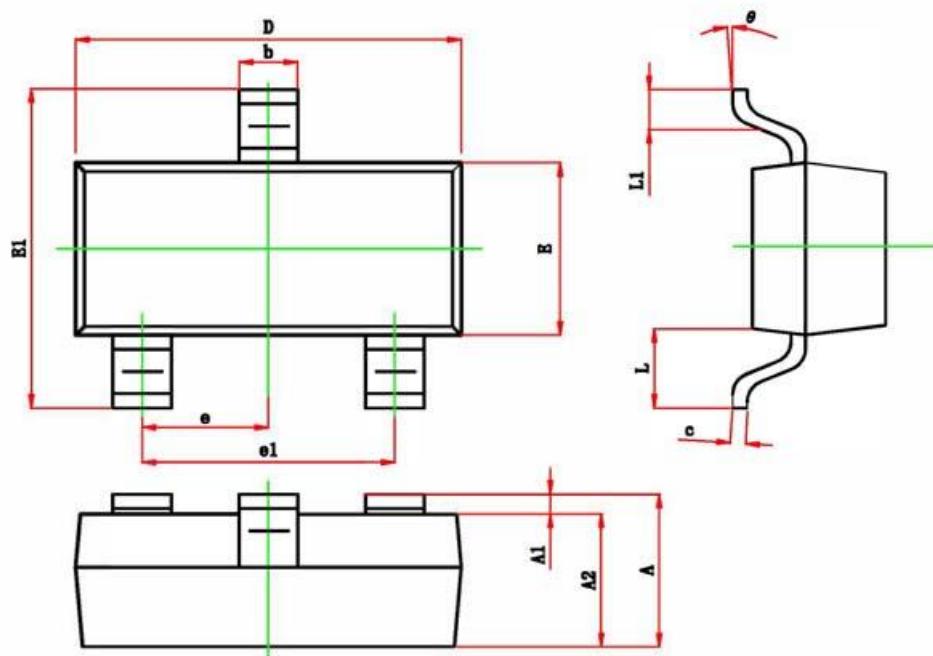
**Notes:**

1. The maximum current rating is limited by Package.
2. Pulse Test ;Pulse Width  $\leq 10\mu\text{s}$ , Duty Cycle  $\leq 1\%$ .
3. Pulse Test ;Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. The power dissipation  $P_{\text{D}}$  is limited by  $T_{\text{J}(\text{MAX})} = 150^\circ\text{C}$ .
5. Device mounted on 1in<sup>2</sup> FR-4 board with 2oz.Copper,in a still air environment with  $T_a = 25^\circ\text{C}$ .

### Typical Electrical and Thermal Characteristics



SOT-23 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 REF.		0.037 REF.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°